

## N-Channel Enhancement Mode Power MOSFET

<p><b>Description</b></p> <p>The G2312 uses advanced trench technology to provide excellent <math>R_{DS(ON)}</math>, low gate charge. It can be used in a wide variety of applications.</p> <p><b>General Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS}</math> 20V</li> <li>● <math>I_D</math> (at <math>V_{GS} = 10V</math>) 5A</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = 4.5V</math>) &lt; 17mΩ</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = 2.5V</math>) &lt; 20mΩ</li> <li>● 100% Avalanche Tested</li> <li>● RoHS Compliant</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● Power switch</li> <li>● DC/DC converters</li> </ul>	<p>Schematic diagram</p> <p>SOT-23</p>
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<b>Ordering Information</b>			
<b>Device</b>	<b>Package</b>	<b>Marking</b>	<b>Packaging</b>
G2312	SOT-23	G2312	3000pcs/Reel

<b>Absolute Maximum Ratings</b> $T_C = 25^\circ\text{C}$ , unless otherwise noted			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Drain-Source Voltage	$V_{DS}$	20	V
Continuous Drain Current	$I_D$	5	A
Pulsed Drain Current (note1)	$I_{DM}$	20	A
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Power Dissipation	$P_D$	1.25	W
Single pulse avalanche energy (note2)	$E_{AS}$	8	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 To 150	$^\circ\text{C}$

<b>Thermal Resistance</b>			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Thermal Resistance, Junction-to-Ambient, $t \leq 10\text{s}$	$R_{thJA}$	100	$^\circ\text{C/W}$

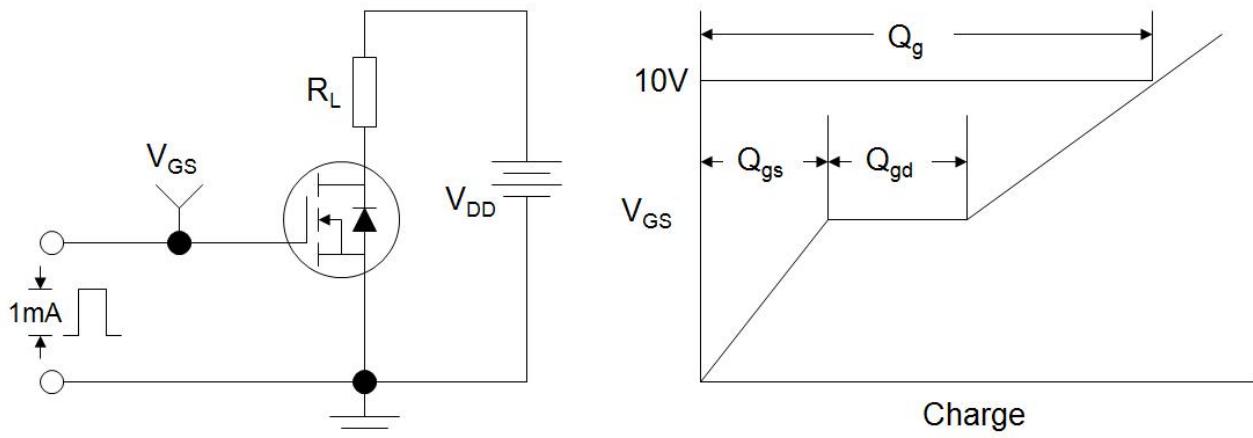
**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	20	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}$	--	--	1	$\mu\text{A}$
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{GS} = \pm 12\text{V}$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.4	0.7	1.0	V
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = 4.5\text{V}, I_D = 3\text{A}$	--	13	17	$\text{m}\Omega$
		$V_{GS} = 2.5\text{V}, I_D = 2\text{A}$	--	16	20	
Forward Transconductance	$g_{\text{FS}}$	$V_{GS} = 5\text{V}, I_D = 3\text{A}$	--	20	--	S
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{GS} = 0\text{V}, V_{DS} = 10\text{V}, f = 1.0\text{MHz}$	--	830	--	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$		--	132	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	119	--	
Total Gate Charge	$Q_g$	$V_{DD} = 10\text{V}, I_D = 3\text{A}, V_{GS} = 4.5\text{V}$	--	10.5	--	$\text{nC}$
Gate-Source Charge	$Q_{gs}$		--	1.5	--	
Gate-Drain Charge	$Q_{gd}$		--	3	--	
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{DD} = 10\text{V}, I_D = 3\text{A}, R_G = 3\Omega$	--	6.5	--	$\text{ns}$
Turn-on Rise Time	$t_r$		--	43	--	
Turn-off Delay Time	$t_{d(\text{off})}$		--	28	--	
Turn-off Fall Time	$t_f$		--	30	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$	$T_C = 25^\circ\text{C}$	--	--	5	A
Body Diode Voltage	$V_{SD}$	$T_J = 25^\circ\text{C}, I_{SD} = 3\text{A}, V_{GS} = 0\text{V}$	--	--	1.2	V
Reverse Recovery Charge	$Q_{rr}$	$I_F = 3\text{A}, V_{GS} = 0\text{V}$ $dI/dt = 100\text{A}/\mu\text{s}$	--	10	--	$\text{nC}$
Reverse Recovery Time	$T_{rr}$		--	18	--	ns

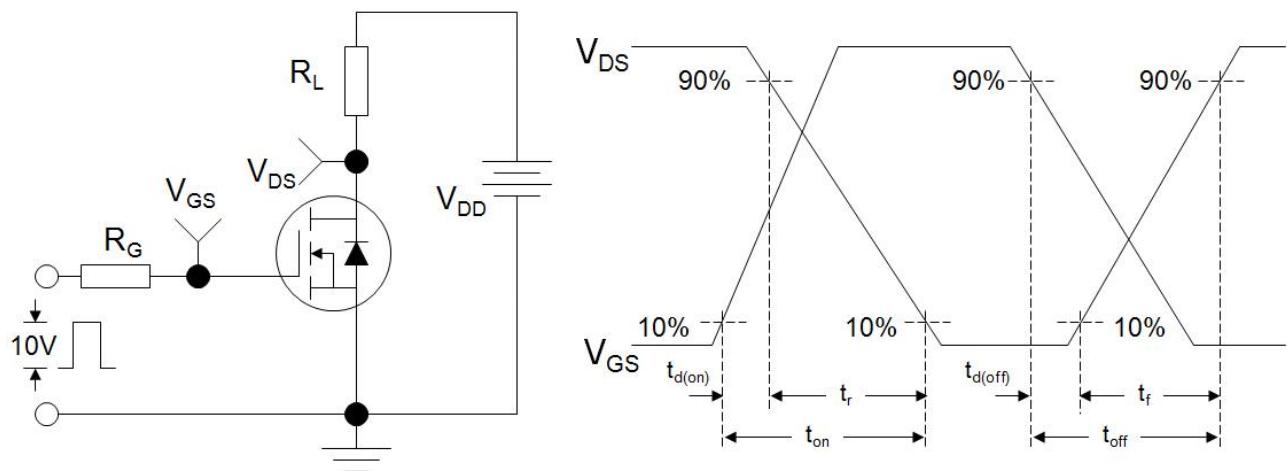
**Notes**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. EAS condition :  $T_J=25^\circ\text{C}$ ,  $V_{DD}=20\text{V}$ ,  $V_{GS}=10\text{V}$ ,  $L=0.5\text{mH}$ ,  $R_G=25\Omega$
3. Identical low side and high side switch with identical  $R_G$

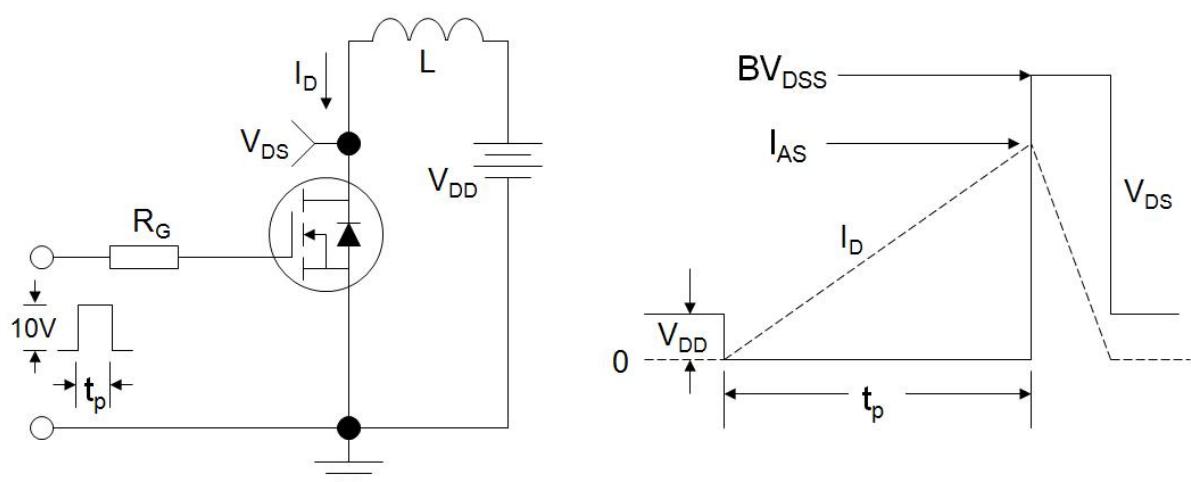
### Gate Charge Test Circuit



### Switch Time Test Circuit

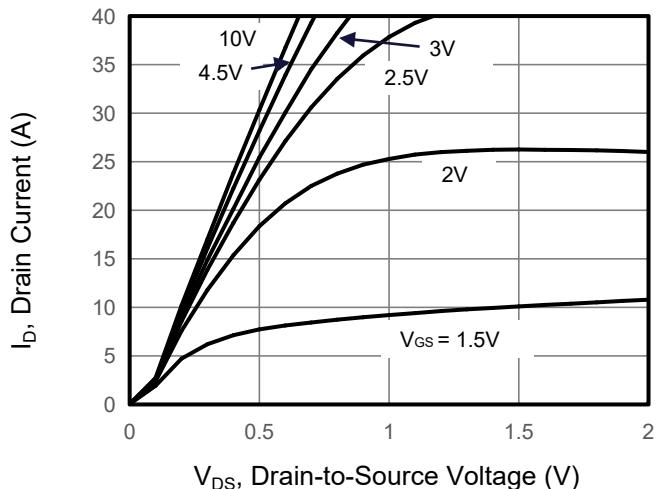


### EAS Test Circuit

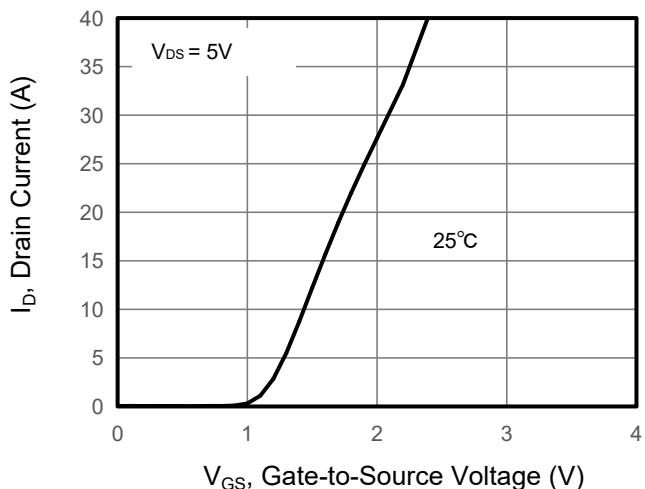


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

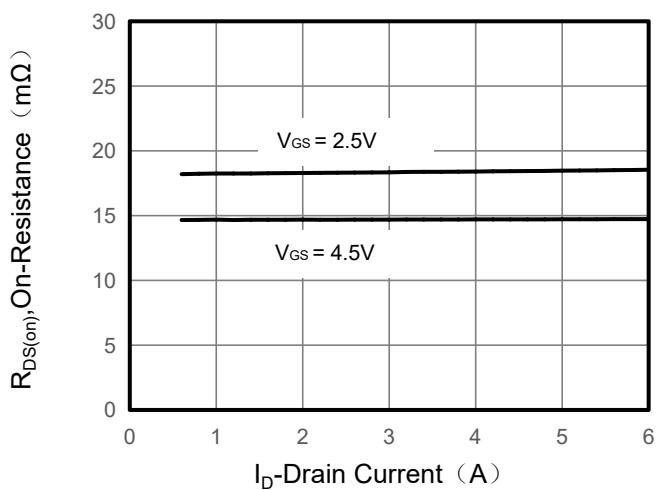
**Figure 1. Output Characteristics**



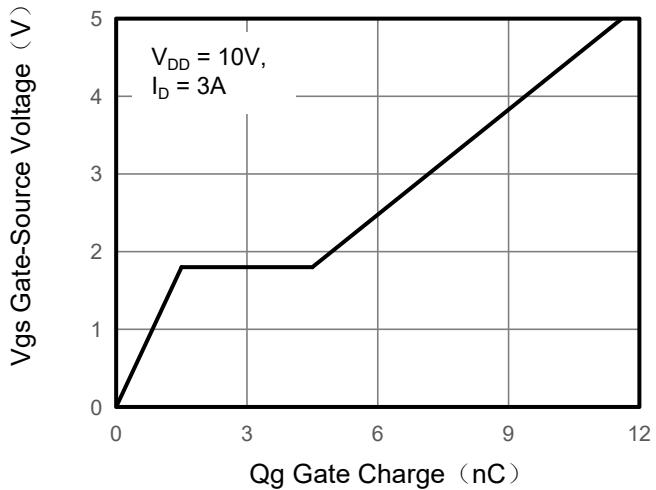
**Figure 2. Transfer Characteristics**



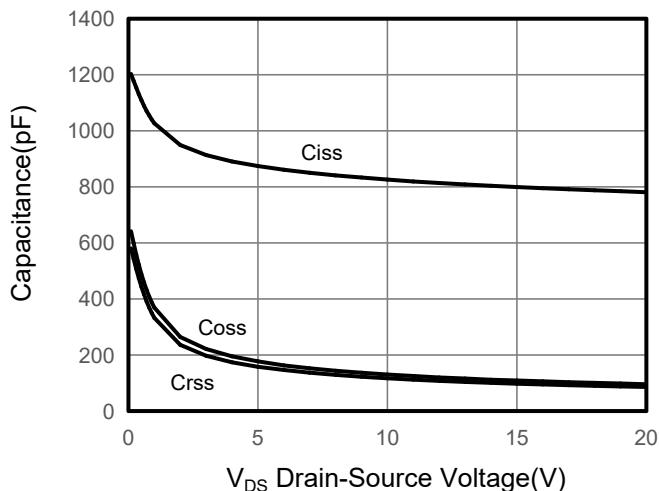
**Figure 3. Drain Source On Resistance**



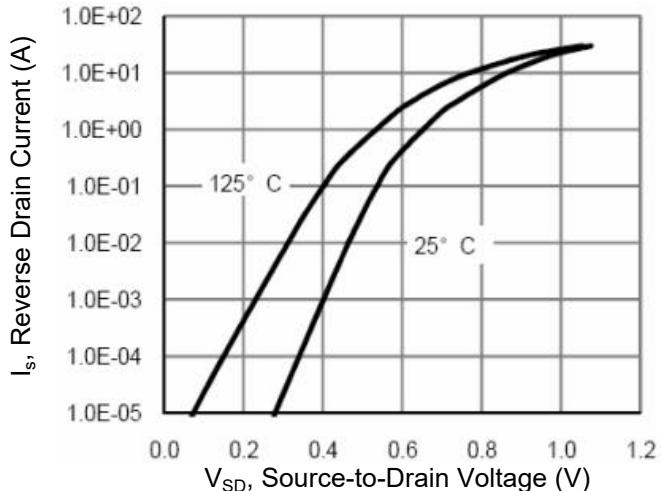
**Figure 4. Gate Charge**



**Figure 5. Capacitance**

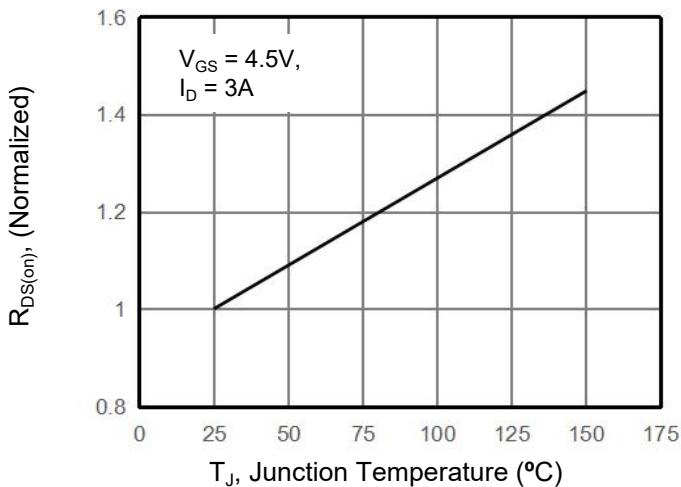


**Figure 6. Source-Drain Diode Forward**

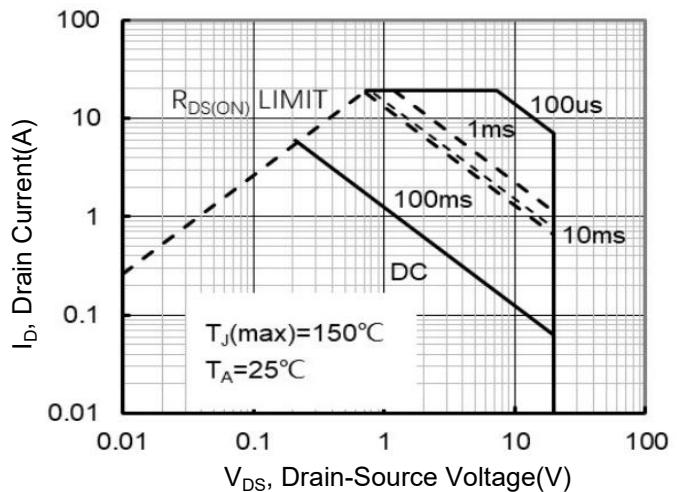


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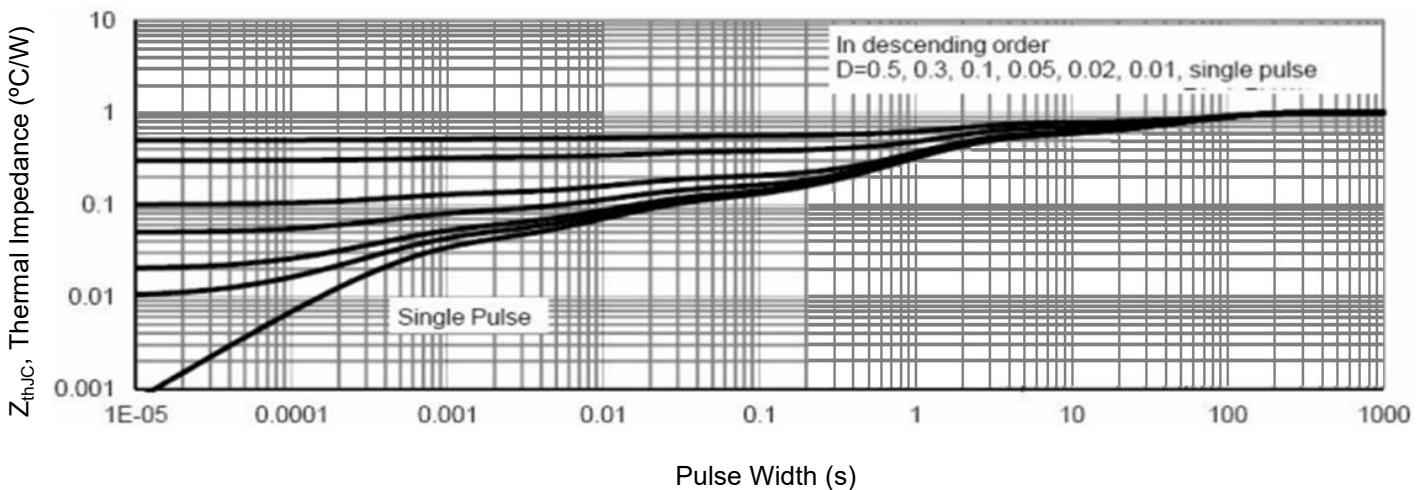
**Figure 7. Drain-Source On-Resistance**

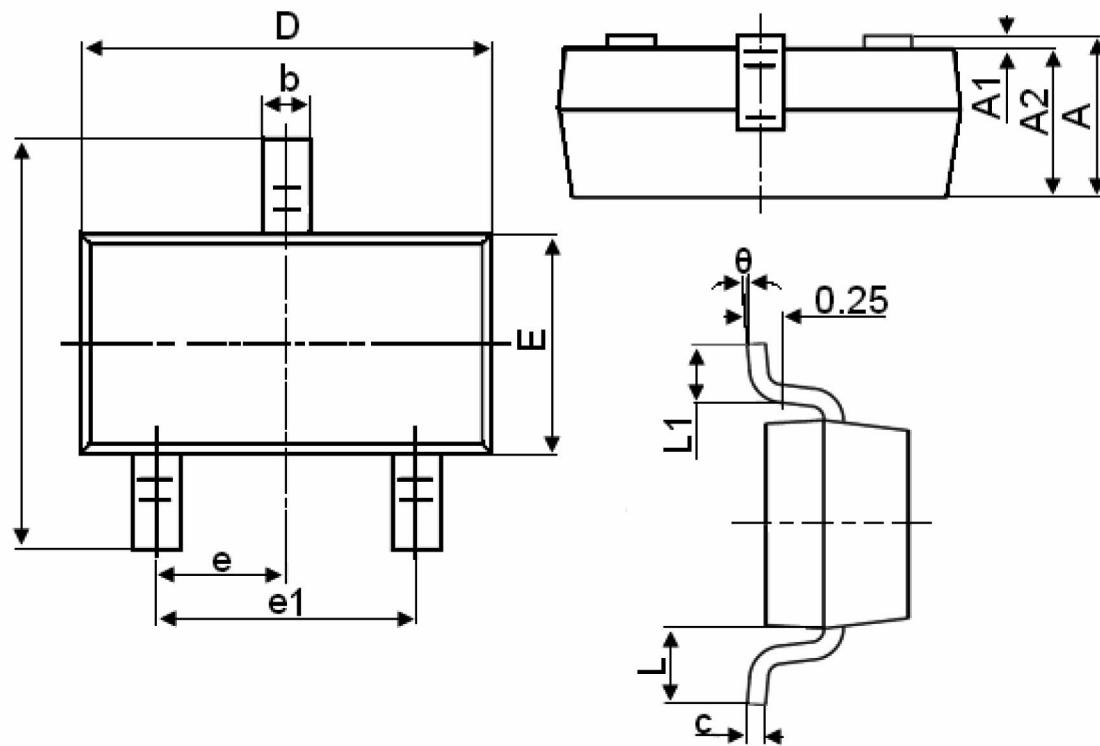


**Figure 8. Safe Operation Area**



**Figure 9. Normalized Maximum Transient Thermal Impedance**



**SOT-23 Package Information**

Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°